

FORWARD CONDUCTION							
PARAMETER	SYMBOL	TEST CONDITIONS			26MB-A	36MB-A	UNITS
Maximum DC output current at case temperature	I <sub>O</sub>	Resistive or inductive load			25	35	A
		Capacitive load			20	28	
					65	60	°C
Maximum peak, one cycle non-repetitive forward current	I <sub>FSM</sub>	t = 10 ms	No voltage reapplied	Initial T <sub>J</sub> = T <sub>J</sub> maximum	400	475	A
		t = 8.3 ms			420	500	
		t = 10 ms	100 % V <sub>RRM</sub> reapplied		335	400	
		t = 8.3 ms			350	420	
Maximum I <sup>2</sup> t for fusing	I <sup>2</sup> t	t = 10 ms	No voltage reapplied		790	1130	A <sup>2</sup> s
		t = 8.3 ms			725	1030	
		t = 10 ms	100 % V <sub>RRM</sub> reapplied		560	800	
		t = 8.3 ms			512	730	
Maximum I <sup>2</sup> √t for fusing	I <sup>2</sup> √t	I <sup>2</sup> t for time t <sub>x</sub> = I <sup>2</sup> √t x √t <sub>x</sub> ; 0.1 ≤ t <sub>x</sub> ≤ 10 ms, V <sub>RRM</sub> = 0 V			5.6	11.3	kA <sup>2</sup> √s
Low level of threshold voltage	V <sub>F(TO)1</sub>	(16.7 % x π x I <sub>F(AV)</sub> ) < I < π x I <sub>F(AV)</sub> ), T <sub>J</sub> maximum			0.70	0.74	V
High level of threshold voltage	V <sub>F(TO)2</sub>	(I > π x I <sub>F(AV)</sub> ), T <sub>J</sub> maximum			0.75	0.79	
Low level forward slope resistance	r <sub>t1</sub>	(16.7 % x π x I <sub>F(AV)</sub> ) < I < π x I <sub>F(AV)</sub> ), T <sub>J</sub> maximum			7.0	5.5	mΩ
High level forward slope resistance	r <sub>t2</sub>	(I > π x I <sub>F(AV)</sub> ), T <sub>J</sub> maximum			6.4	5.2	
Maximum forward voltage drop	V <sub>FM</sub>	T <sub>J</sub> = 25 °C, I <sub>FM</sub> = 40 Apk (26MB)		t <sub>p</sub> = 400 μs	1.25	1.3	V
		T <sub>J</sub> = 25 °C, I <sub>FM</sub> = 55 Apk (36MB)					
Maximum DC reverse current per diode	I <sub>RRM</sub>	T <sub>J</sub> = 25 °C, at V <sub>RRM</sub>			10	10	μA
RMS isolation voltage base plate	V <sub>ISOL</sub>	f = 50 Hz, t = 1 s			2700	2700	V

THERMAL AND MECHANICAL SPECIFICATIONS					
PARAMETER	SYMBOL	TEST CONDITIONS	26MB-A	36MB-A	UNITS
Junction and storage temperature range	T <sub>J</sub> , T <sub>Stg</sub>		- 55 to 150		°C
Maximum thermal resistance, junction to case per bridge	R <sub>thJC</sub>		1.7	1.35	K/W
Maximum thermal resistance, case to heatsink	R <sub>thCS</sub>	Mounting surface, smooth, flat and greased	0.2		
Mounting torque ± 10 %		Bridge to heatsink	2.0		Nm
Approximate weight			20		g



## MB High Voltage Series

Single Phase Bridge  
(Power Modules), 25 A/35 A

Vishay High Power Products

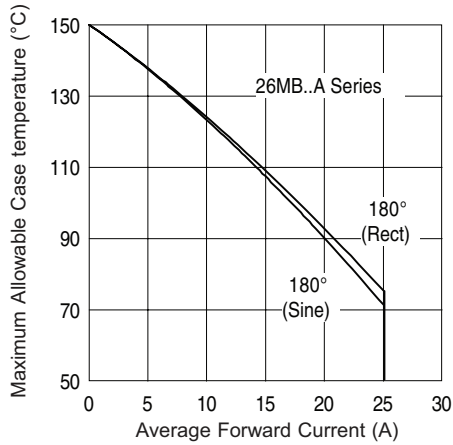


Fig. 1 - Current Ratings Characteristics

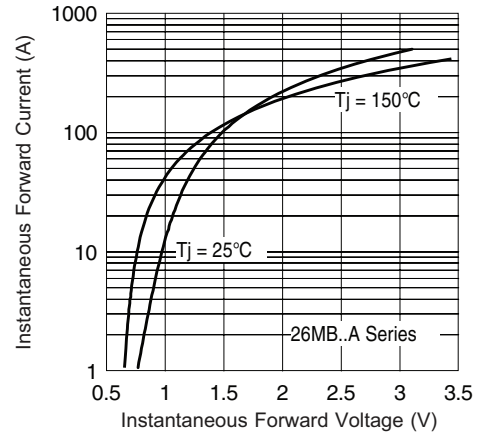


Fig. 2 - Forward Voltage Drop Characteristics

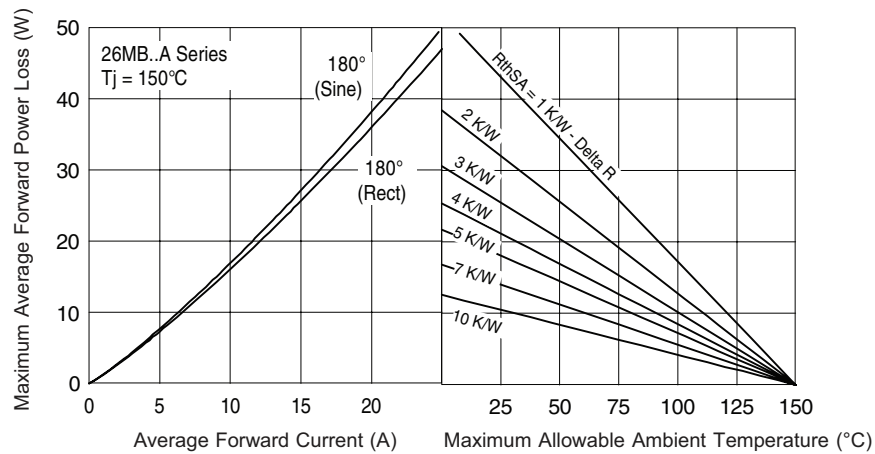


Fig. 3 - Total Power Loss Characteristics

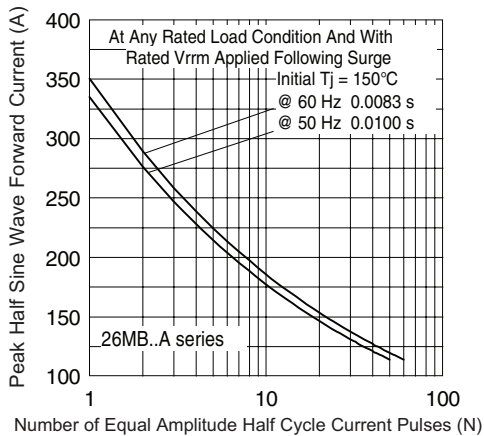


Fig. 4 - Maximum Non-Repetitive Surge Current

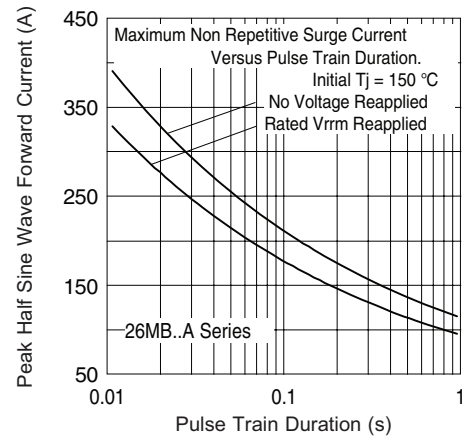


Fig. 5 - Maximum Non-Repetitive Surge Current

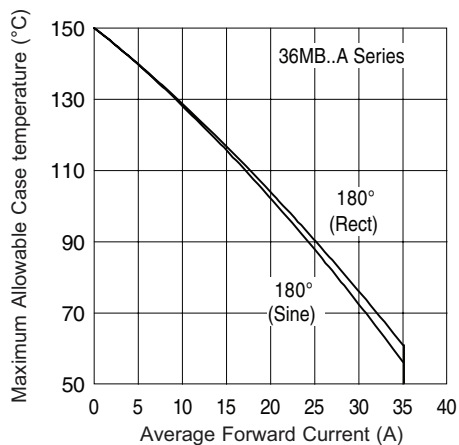


Fig. 6 - Current Ratings Characteristics

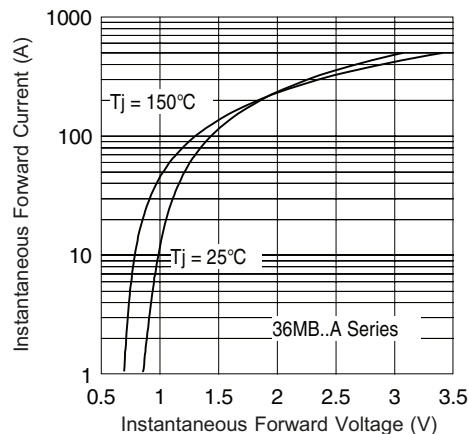


Fig. 7 - Forward Voltage Drop Characteristics

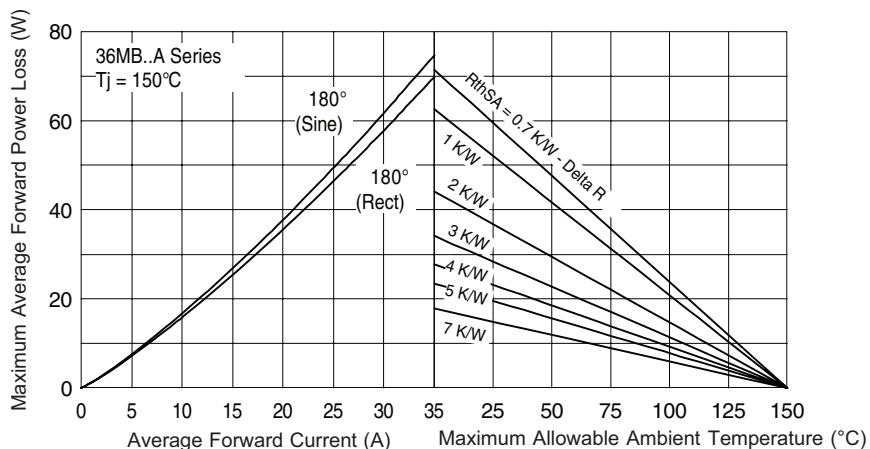


Fig. 8 - Total Power Loss Characteristics

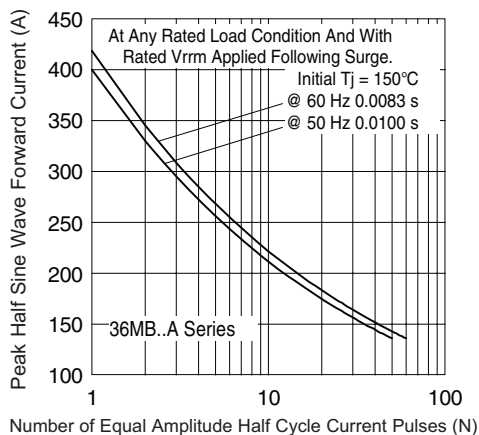


Fig. 9 - Maximum Non-Repetitive Surge Current

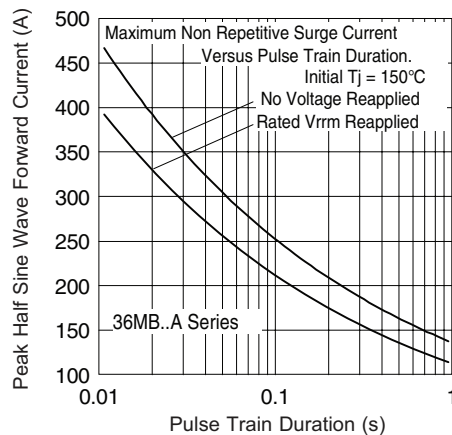


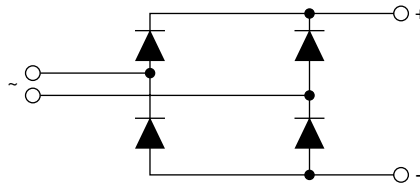
Fig. 10 - Maximum Non-Repetitive Surge Current



## ORDERING INFORMATION TABLE

Device code	36	MB	160	A
	1	2	3	4
1	- Current rating code			26 = 25 A (average) 36 = 35 A (average)
2	- Circuit configuration:			MB = Single phase european coding
3	- Voltage code x 10 = $V_{RRM}$			
4	- Diode bridge rectifier:			A = 26 MB, 36MB series

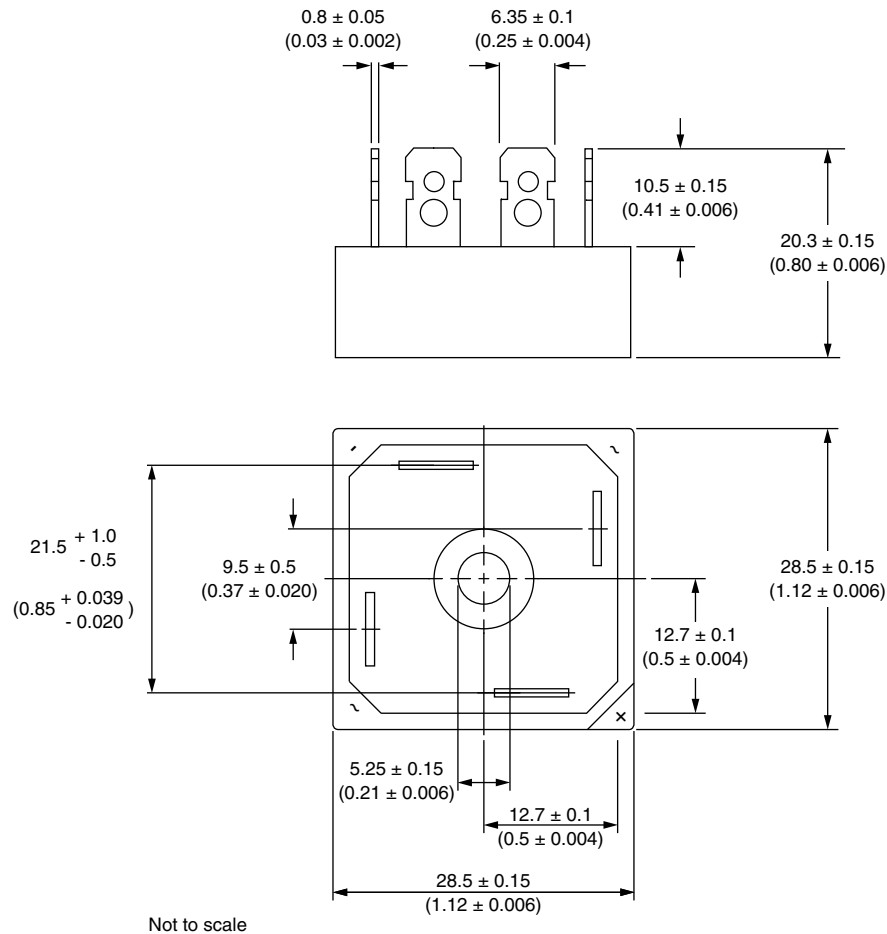
## CIRCUIT CONFIGURATION



LINKS TO RELATED DOCUMENTS	
Dimensions	<a href="http://www.vishay.com/doc?95326">http://www.vishay.com/doc?95326</a>

## D-34

**DIMENSIONS** in millimeters (inches)



Suggested plugging force:  
200 N max; axially applied to fast-on terminals



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